

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC7292AP, TC74HC7292AF

Programmable Divider/Timer

The TC74HC7292A is a high speed CMOS PROGRAMMABLE DIVIDER/TIMER fabricated with silicon gate C²MOS technology. It achieves the high speed operation similar to equivalent LSTTL

while maintaining the CMOS low power dissipation.

The TC74HC7292A can divide from 2² to 2³¹.

CK1 and CK2 are clock inputs, either one may be used for clock gating.

It features an active-low clear input to initialize the state of all flip-flops.

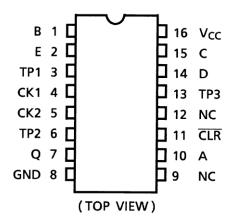
To facilitate incoming inspection, test points are provided. (TP1, TP2 and TP3)

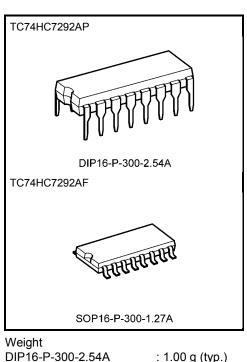
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: fmax = 70 MHz (typ.) at VCC = 5 V
- Low power dissipation: ICC = 4 μ A (max) at Ta = 25°C •
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- Output drive capability: 10 LSTTL loads .
- Symmetrical output impedance: |IOH| = IOL = 4 mA (min)
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS292

Pin Assignment





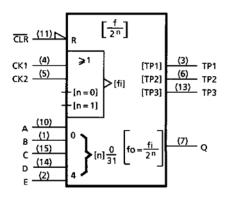
SOP16-P-300-1.27A

: 0.18 g (typ.)

Start of commercial production 1988-11

TOSHIBA

IEC Logic Symbol



Truth Table

CLR	CK1	CK2	Q Output Mode
L	Х	Х	Cleared to L
Н		L	Lin Count
н	L		Up Count
Н	Н	Х	No Change
Н	Х	Н	No Change

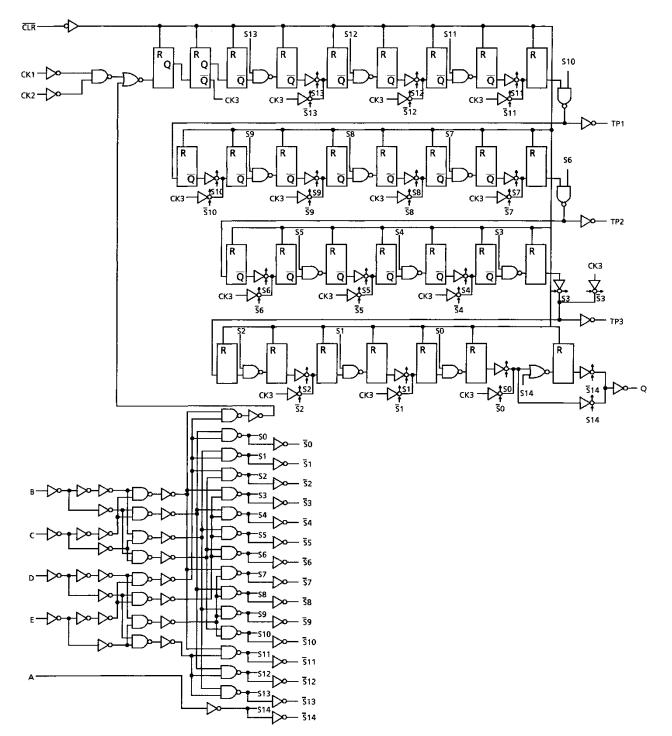
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TC74HC7292AP/AF

F	Prog	ram	ming)	Frequency Division							
	Ir	nput	s			Q	TP1		TP2	2		TP3
Е	D	С	В	А	Binary	Decimal	Binary	Decimal	Binary	Decimal	Binary	Decimal
L	L	L	L	L	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit
L	L	L	L	Н	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit
L	L	L	Н	L	2 ²	4	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	L	Н	Н	2 ³	8	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	Н	L	L	24	16	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	Н	L	н	2 ⁵	32	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	Н	Н	L	2 ⁶	64	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	Н	Н	Н	2 ⁷	128	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	Н	L	L	L	2 ⁸	256	2 ⁹	512	2 ¹⁷	131,072	2 ²	4
L	Н	L	L	н	2 ⁹	512	2 ⁹	512	2 ¹⁷	131,072	2 ²	4
L	Н	L	Н	L	2 ¹⁰	1,024	2 ⁹	512	2 ¹⁷	131,072	2 ⁴	16
L	Н	L	Н	Н	2 ¹¹	2,048	2 ⁹	512	2 ¹⁷	131,072	2 ⁴	16
L	Н	Н	L	L	2 ¹²	4,096	2 ⁹	512	2 ¹⁷	131,072	2 ⁶	64
L	Н	Н	L	Н	2 ¹³	8,192	2 ⁹	512	2 ¹⁷	131,072	2 ⁶	64
L	Н	Н	Н	L	2 ¹⁴	16,384	2 ⁹	512	Disabled Low		2 ⁸	256
L	Н	Н	Н	Н	2 ¹⁵	32,768	2 ⁹	512	Disabled Low		2 ⁸	256
н	L	L	L	L	2 ¹⁶	65,536	2 ⁹	512	2 ³	8	2 ¹⁰	1,024
н	L	L	L	Н	2 ¹⁷	131,072	2 ⁹	512	2 ³	8	2 ¹⁰	1,024
н	L	L	Н	L	2 ¹⁸	262,144	2 ⁹	512	2 ⁵	32	2 ¹²	4,096
н	L	L	Н	Н	2 ¹⁹	524,288	2 ⁹	512	2 ⁵	32	2 ¹²	4,096
н	L	Н	L	L	2 ²⁰	1,048,576	2 ⁹	512	27	128	2 ¹⁴	16,384
н	L	Н	L	н	2 ²¹	2,097,152	2 ⁹	512	2 ⁷	128	2 ¹⁴	16,384
н	L	Н	Н	L	2 ²²	4,194,304	Disabled Low		2 ⁹	512	2 ¹⁶	65,536
н	L	Н	Н	Н	2 ²³	8,388,608	Disabled Low		2 ⁹	512	2 ¹⁶	65,536
н	Н	L	L	L	2 ²⁴	16,777,216	2 ³	8	2 ¹¹	2,048	2 ¹⁸	262,144
н	Н	L	L	н	2 ²⁵	33,554,432	2 ³	8	2 ¹¹	2,048	2 ¹⁸	262,144
н	Н	L	Н	L	2 ²⁶	67,108,864	2 ⁵	32	2 ¹³	8,192	2 ²⁰	1,048,576
н	Н	L	Н	н	2 ²⁷	134,217,728	2 ⁵	32	2 ¹³	8,192	2 ²⁰	1,048,576
н	Н	Н	L	L	2 ²⁸	268,435,456	27	128	2 ¹⁵	32,768	222	4,194,304
н	Н	Н	L	н	2 ²⁹	536,870,912	2 ⁷	128	2 ¹⁵	32,768	2 ²²	4,194,304
н	Н	Н	Н	L	2 ³⁰	1,073,741,824	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
н	Н	Н	Н	н	2 ³¹	2,147,483,648	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216



System Diagram



Absolute Maximum Ratings

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vcc	-0.5 to 7	V
DC input voltage	VIN	-0.5 to V _{CC} + 0.5	V
DC output voltage	Vout	-0.5 to V _{CC} + 0.5	V
Input diode current	liк	±20	mA
Output diode current	ЮК	±20	mA
DC output current	IOUT	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	PD	500 (DIP) (Note 1)/180 (SOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating	Ranges
-	

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2 to 6	V
Input voltage	VIN	0 to V _{CC}	V
Output voltage	Vout	0 to Vcc	V
Operating temperature	Topr	-40 to 85	°C
Input rise and fall time	tr, tf	0 to 1000 (V _{CC} = 2.0 V) 0 to 500 (V _{CC} = 4.5 V) 0 to 400 (V _{CC} = 6.0 V)	ns

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		٦	Га = 25°()	-	a = 85°C	Unit	
Characteristics	Symbol				Min	Тур.	Max	Min	Max	Unit
High-level input				2.0	1.50			1.50		
voltage	VIH		—	4.5 6.0	3.15 4.20	_	_	3.15 4.20	_	V
				2.0	—	_	0.50	_	0.50	
Low-level input voltage	VIL		—	4.5		—	1.35	—	1.35	V
				6.0			1.80		1.80	
	V _{OH}	VIN = VIH or VIL		2.0	1.9	2.0		1.9		
			I _{OH} = -20 μA	4.5	4.4	4.5	_	4.4	_	
High-level output voltage (Q)				6.0	5.9	6.0	—	5.9	—	V
Voltage (Q)			IOH = -4 mA	4.5	4.18	4.31	_	4.13	_	
			IOH = -5.2 mA	6.0	5.68	5.80	—	5.63	—	
				2.0		0.0	0.1		0.1	
			I _{OL} = 20 μΑ	4.5		0.0	0.1	—	0.1	
Low-level output voltage (Q)	VOL	V _{IN} = V _{IH} or V _{IL}		6.0		0.0	0.1	—	0.1	V
Voltage (Q)			I _{OL} = 4 mA	4.5		0.17	0.26		0.33	
			I _{OL} = 5.2 mA	6.0		0.18	0.26	—	0.33	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0	_	_	±0.1		±1.0	μA
Quiescent supply current	Icc	V _{IN} = V _{CC} or	GND	6.0	_		4.0		40.0	μA

Timing Requirements (input: t_r = t_f = 6 ns)

Characteristics	Symbol Test Condition			Ta = 25°C		Ta = -40 to 85°C	Unit	
			Vcc (V)	Тур.	Limit	Limit		
Minimum pulse width (CK)	tw (L) tw (H)	_	2.0 4.5 6.0		75 15 13	95 19 16	ns	
Minimum pulse width (CLR)	tw (L)	_	2.0 4.5 6.0		175 35 30	220 44 37	ns	
Minimum removal time	t _{rem}	—	2.0 4.5 6.0		5 5 5	5 5 5	ns	
Clock frequency	f	_	2.0 4.5 6.0		5 27 32	4 22 26	MHz	



AC Characteristics (C_L = 15 pF, V_{CC} = 5 V, Ta = 25°C, input: t_r = t_f = 6 ns)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time (Q)	tтlн tтнL	—	_	4	8	ns
Output transition time (TP)	tтlн tтнL	_		25	44	ns
Propagation delay time (CK-Q)	t _{pLH} t _{pHL}	_		42	75	ns
Propagation delay time (CLR -Q)	tpHL	—		36	62	ns
Maximum clock frequency	f _{max}	_	30	70		MHz

AC Characteristics (C_L = 50 pF, input: t_r = t_f = 6 ns)

Characteristics	Symbol	Test Condition		1	Га = 25°С)		a = 85°C	Unit
Characteristics	Symbol		Vcc (V)	Min	Тур.	Max	Min	Max	Onit
Output transition time (Q)	tт∟н tтн∟		2.0 4.5 6.0		27 9 8	75 15 13		95 19 16	ns
Output transition time (TP)	t⊤LH t⊤HL		2.0 4.5 6.0		90 30 25	250 50 43		315 63 54	ns
Propagation delay time (CK-Q)	t _{pLH} t _{pHL}	l	2.0 4.5 6.0		150 48 41	425 85 72		530 106 90	ns
Propagation delay time (CLR -Q)	tpHL	_	2.0 4.5 6.0		130 42 36	350 70 60		440 88 75	ns
Maximum clock frequency	fmax	_	2.0 4.5 6.0	5 27 32	20 64 75		4 22 26		MHz
Input capacitance	CIN			_	5	10	_	10	pF
Power dissipation capacitance	Cpd		(Note)		22		_	_	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

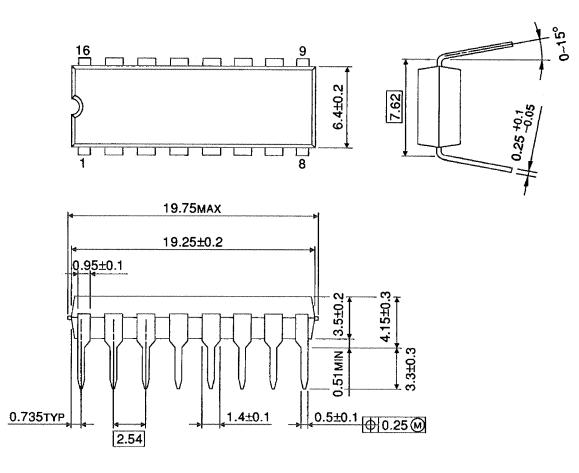
 $ICC (opr) = CPD \cdot VCC \cdot fIN + ICC$



Package Dimensions

DIP16-P-300-2.54A

Unit : mm



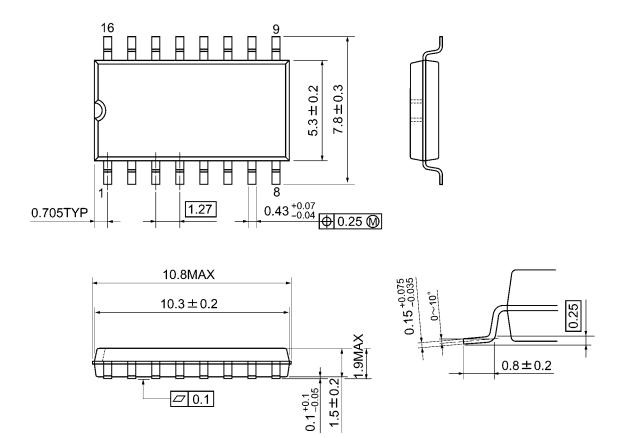
Weight: 1.00 g (typ.)



Package Dimensions

SOP16-P-300-1.27A

Unit: mm



Weight: 0.18 g (typ.)

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